## Trench-based Schottky Diode, 500 mA, 30 V

# NSR05301MX4

These Schottky diodes are optimized for low forward voltage drop and low leakage current that offers the most optimal power dissipation in applications. They are housed in space saving micro-packaging ideal for space constrained applications.

#### Features

- Smallest Package Available (01005); 0.445mm x 0.24mm
- 500 mA of Continuous Forward Current
- Low Forward Voltage Drop 430 mV (Typical) @ I<sub>F</sub> = 200 mA
- Low Reverse Current 25  $\mu$ A (Typical) @ V<sub>R</sub> = 30 V
- Low Reverse Recovery Time 9 ns Typical
- Low Capacitance 19 pF Typical

#### **Typical Applications**

- Mobile and Wearable Devices
- LED Boost Converters
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

#### MAXIMUM RATINGS

				1
	Rating	Symbol	Value	Unit
Forward Current	(DC)	١ <sub>F</sub>	500	mA
Reverse Voltage		VR	<b>G</b> 30	J V
Repetitive Peak F (Pulse Wave = 1	Forward Current sec, Duty Cycle = 66%)	IFRM	1.0	А
ESD Rating:	Human Body Model Machine Model	ESD	>8.0 >400	kV V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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## ORDERING INFORMATION

Device	Package	Shipping†
NSR05301MX4T5G	X4DFN2 (Pb-Free)	10000 / Tape & Reel

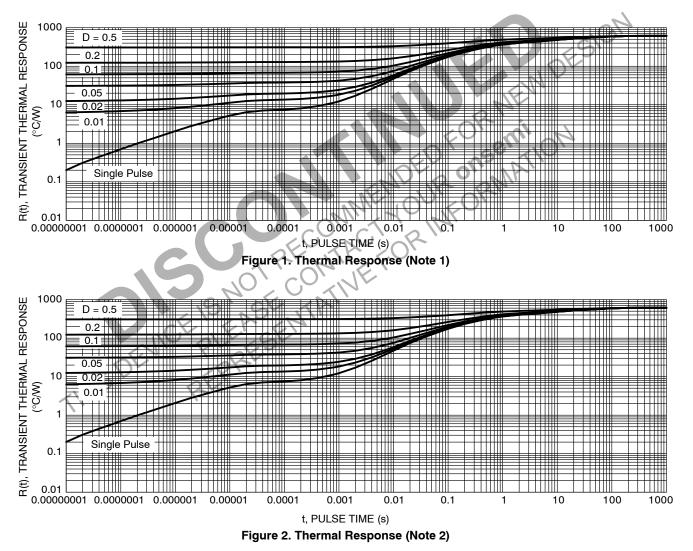
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit	
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T <sub>A</sub> = 25°C	R <sub>eja</sub> P <sub>D</sub>	614.9 203	°C/W mW	
Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ T <sub>A</sub> = 25°C	$R_{\theta JA}$ $P_{D}$	239.4 522	°C/W mW	
Junction Temperature Range	TJ	-55 to +125	°C	
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C	
Lead Solder Temperature - Maximum (10 seconds)	TL	260	°C	

1. Mounted onto a 4 in<sup>2</sup> FR-4 board 10 mm<sup>2</sup> 1 oz. Cu 0.06' thick single-sided. Operating to steady state.

2. Mounted onto a 4 in<sup>2</sup> FR-4 board 2 cm<sup>2</sup> 1 oz. Cu 0.06' thick single-sided. Operating to steady state.

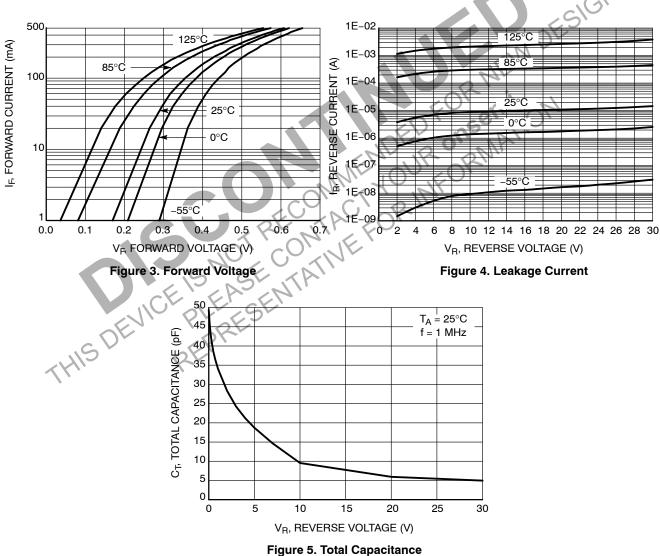


### NSR05301MX4

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

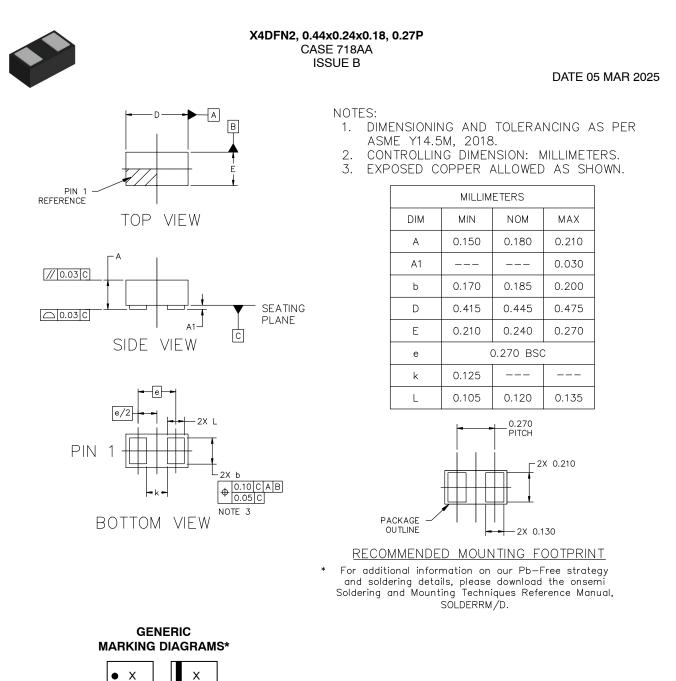
Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage $(V_R = 10 \text{ V})$ $(V_R = 30 \text{ V})$	Ι <sub>R</sub>		15 25	50 100	μΑ
Forward Voltage (I <sub>F</sub> = 100 mA) (I <sub>F</sub> = 200 mA) (I <sub>F</sub> = 500 mA)	V <sub>F</sub>		355 430 640	480 540 800	mV
Total Capacitance (V <sub>R</sub> = 5.0 V, f = 1 MHz)	C <sub>T</sub>		19		pF
Reverse Recovery Time ( $I_F = I_R = 10 \text{ mA}, I_{R(REC)} = 1.0 \text{ mA}$ )	t <sub>rr</sub>		9.0	11	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



# TYPICAL CHARACTERISTICS

# onsemi



 X = Specific Device Code
\*This information is generic. Please refer to device data sheet for actual part marking.
Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may

not follow the Generic Marking.

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DESCRIPTION:	X4DFN2, 0.44x0.24x0.18, 0.27P		PAGE 1 OF 1

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